## **Hisense International Co., Ltd.**

## **Declaration of Identity**

Hereby,

Name of manufacturer: <u>Hisense International Co., Ltd.</u>

Address: Floor 22, Hisense Tower, 17 Donghai Xi Road, Qingdao, 266071, China

City: Qingdao,

Country: China

declares that this equipment:

Product description: <u>Smartphone</u>

Type designation(s): HLTE230E

Trademark: Hisense

FCC ID **2ADOBHLTE230E** 

is different on

the supplier of Memory/Camera/LCD.

Main Supply

| Part Name   | Model               | Supplier(Brand)                    | Description                |
|-------------|---------------------|------------------------------------|----------------------------|
| Memory      | UNMEN06GC2C31AS     | UNIC2                              | eMMC5.1                    |
|             |                     |                                    | Module,64GB,FBGA-153Ball   |
| Memory      | MT53E768M32D2NP-053 | Micron                             | LPDDR4X,24Gb(768 Meg x 32  |
|             | RS                  |                                    | (2 channels x 16           |
|             |                     |                                    | I/O)),WFBGA-200Ball        |
| Camera      | H8B13-KS230FF       | Kingcome                           | HI1336,COB,S1326A          |
| Camera      | H7B8-KS230BF        | Kingcome                           | HI-846,COB,S0883A          |
| Camera      | H9B13-KS230BA       | Kingcome                           | HI1336,COB,3933C-400       |
| Camera      | BC12903V0           | CXT                                | GC2385,CSP,HX-M0207H-H306  |
| Camera      | BC12904V0           | CXT                                | GC02M1B,CSP,HX-M0207B-H201 |
| LCD+TP      | HTF065H029          | HOLITECH                           | ICNL9911S,MLAF065WE51      |
| fingerprint | TW-SW331B-KS230-V1  | TOWO                               | SW331B                     |
| Battery     | PLV436190           | ShenzhenAerospaceElectronicCo.,Ltd |                            |

## **Hisense International Co., Ltd.**

## Secondary Supply

| Part Name   | Model Name            | supplier                    | Remark                         |
|-------------|-----------------------|-----------------------------|--------------------------------|
| Memory      | NCEMASLD-64G          | FORESEE                     | eMMC5.1                        |
|             |                       |                             | Module,64GB,FBGA-153Ball       |
| Memory      | RS768M32LB4D2BDS-53BT | RAYSON                      | LPDDR4X,24Gb(768Mb x 16I/O x 2 |
|             |                       |                             | channels), WFBGA-200Ball       |
| Camera      | TW-130V53-KS230F-V1   | TOWO                        | OV13853,COB,S1326              |
| Camera      | TW-08GC34-KS230B-V1   | TOWO                        | GC8034,COB,1368XX              |
| Camera      | TW-13OV53-KS230B-V1   | TOWO                        | OV13853,COB,50064B17           |
| Camera      | ST-CFKS230-WJBF-V1    | Union Image co.,ltd         | GC2375H,CSP,HX-M0207H-H306     |
| Camera      | ST-CFKS230-JSBF-V1    | Union Image co.,ltd         | GC2375H,CSP,DL2002B10-BP       |
| LCD+TP      | EQT651WKF003G         | easyquick                   | FT8006, MLAF065WE51X           |
| fingerprint | FS22483BJN            | HOLITECH                    | ICNF7332-A2                    |
| Battery     | 436191P               | Shenzhen Tianjin New Energy |                                |
|             |                       | Technology Co., Ltd.        |                                |

| Date:      | <b>20191219</b> |  |
|------------|-----------------|--|
| City:      | Qingdao         |  |
| Name:      |                 |  |
| Signature: |                 |  |